



RECOMMENDED P.C.B. LAYOUT

NOTES:

1. MATERIAL  
 HOUSING: HIGH TEMPERATURE THERMOPLASTIC, WHITE.  
 CONTACT: COPPER ALLOY.  
 PED: BRASS.
2. PLATING  
 CONTACT: UNDERPLATED: 50 u" MIN Ni.  
 CONTACT AREA: 15u" GOLD OVER Ni PLATED.  
 SOLDER TAIL: 100 u" MIN Sn/Pb OVER Ni PLATED.  
 PED: 100 u" MIN Sn/Pb OVER 50 u" MIN Ni PLATED.
3. UNSPECIFIED TOLERANCE: .XX ±0.25[0.010]  
 .X ±0.30[0.012]

TABLE		
Pin Type	Interface Dim.	Pin No.
Detect	3.5mm (0.138In.)	25,26
General	4.25mm (0.167In.)	The others
Power	5.0mm (0.197In.)	01,13,38,50

<h1>XMULTIPLE</h1>		CONNECTING THE INFORMATION AGE	
XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475		XMULTIPLE USA 543 Country Club Drive #B 128 Simi Valley, CA 93065	
THIS DRAWING IS A CONTROLLED DOCUMENT.		CUSTOMER/NO:	
TITLE: CF Card Connector 50Pin Slim Normal Type		DWG NO: XCFC2-50M5-W050-2Q	
PART NO: XCFC2-50M5-W050-2Q		DRAWN: TARA	
		CHKD: C. TSAI	
		DATE: 09/07/04	
DIMENSIONS		SHEET	REV
mm[inch ]		1 of 1	01